**NICHIA CORPORATION** 

### **SPECIFICATIONS FOR WHITE LEDS**

# PART NO. NC2W170HT, NC2W121HT, NC2W121HT-SC













- Pb-free Reflow Soldering Application
- ESD Withstand Voltage (HBM) Class 3B
- RoHS Compliant
- IATF 16949 Compliant
  AEC-Q102 Qualification in progress



#### **FEATURES**

The LEDs in the Nichia CSP family (i.e. the 121, 131, 139, 170, and 179 series LEDs) offer a wide variety of sizes and shapes for the light emitting surface (LES) and color rank options; these LEDs can be used for various automotive applications and increase the design flexibility.

#### LES Sizes and Shapes for the LEDs:

This specification only applies to the part numbers that are provided in the black cells in the table below.

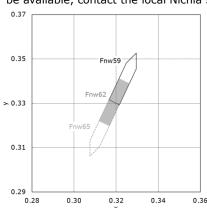
THIS SP	ecinication only applies to the part	mambers that are provided in t	the black cells in the table below.
	NJSW170HT	NJSW170HT-SA	NJSW170HT-SB
2W	0.9 x 0.9mm	0.76 x 0.76mm	0.5 x 0.5mm
	NCSW170HT,NCSW131HT	NCSW170HT-SA,NCSW131HT-SA	A NCSW170HT-SB,NCSW131HT-SB
3W	1.15 x 1.15mm	0.95 x 0.95mm	0.76 x 0.76mm
3 VV	NCSW179HT-D5,NCSW13	9HT-D5 NCS\	W179HT-D6,NCSW139HT-D6
	0.5 x 2.0mm	0.6 x 2	2.0mm
	NC2W170HT,NC2W12	1HT	NC2W121HT-SC
6W	1.15 x 2.3mm	0.75 x	(1.6mm

<sup>\*</sup> The 121, 131, and 139 series LEDs have a die heatsink; by taking advantage of the die heatsink when designing the chosen PCBA, the heat dissipation performance of the chosen application can be maximized.

#### **Color Rank Options:**

#### Color Ranks:

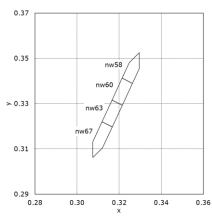
LEDs from the ranks below will be shipped. Each rank can be divided into two sub-bins upon request. Other rank options may be available, contact the local Nichia sales office.



Fnv	v59	Fnw62		Fnv	v65
x	У	X	У	X	У
0.3166	0.3316	0.3118	0.3220	0.3075	0.3062
0.3248	0.3481	0.3214	0.3413	0.3075	0.3132
0.3296	0.3526	0.3263	0.3390	0.3166	0.3316
0.3296	0.3456	0.3167	0.3197	0.3215	0.3293
0.3215	0.3293			0.3121	0.3105

#### Sub-bins:

Nichia can ship LEDs from sub-bins; a sub-bin is a smaller section of a rank and for these products its range is half of the applicable rank. Sub-bins are available only for the ranks listed above. Using LEDs from a sub-bin can reduce color variation that may occur in the chosen application. Note that LEDs from a single sub-bin cannot be ordered; an order must be placed for both of the sub-bins of a rank. The sub-bin combination ratio per shipment will be decided by Nichia.



#### To order LEDs from the sub-bins, place an order with the color ranks listed as below:

- Fnw59: nw58,nw60
- Fnw62: nw60,nw63
- Fnw65: nw63,nw67

nw	58	nw60		nw63		nw67	
	-	1111	-	1100	05	1144	07
X	У	X	У	X	У	X	У
0.3214	0.3413	0.3166	0.3316	0.3118	0.3220	0.3075	0.3062
0.3248	0.3481	0.3214	0.3413	0.3166	0.3316	0.3075	0.3132
0.3296	0.3526	0.3263	0.3390	0.3215	0.3293	0.3118	0.3220
0.3296	0.3456	0.3215	0.3293	0.3167	0.3197	0.3167	0.3197
0.3263	0.339					0.3121	0.3105

<sup>\*</sup> Some of the part numbers shown in the table may be currently under development and not be available yet.

### **SPECIFICATIONS**

(1) Absolute Maximum Ratings

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	${ m I}_{\sf F}$	1500	mA
Pulse Forward Current	${ m I}_{\sf FP}$	3000	mA
ESD Withstand Voltage (HBM)	$V_{ESD}$	8	kV
Allowable Reverse Current	${ m I}_{ m R}$	85	mA
Power Dissipation	P <sub>D</sub>	11.2	W
Operating Temperature	Topr	-40~135	°C
Storage Temperature	T <sub>stg</sub>	-40~135	°C
Junction Temperature	T <sub>3</sub>	150	°C

<sup>\*</sup> Absolute Maximum Ratings at T<sub>J</sub>=25°C.

(2) Initial Electrical/Optical Characteristics

(2) Initial Electrical Opti	f Initial Electrical Optical Characteristics						
Item		Symbol	Part number	Condition	Тур	Unit	
Forward Voltage V <sub>F</sub>		All 3 part numbers	I <sub>F</sub> =1000mA	6.5	V		
		_	NC2W170HT, NC2W121HT		950		
Luminous Flux		Ф	NC2W121HT-SC	I <sub>F</sub> =1000mA	760	lm	
	х			I <sub>F</sub> =1000mA	0.325		
Chromaticity Coordinate	v	] -	All 3 part numbers	I <sub>F</sub> =1000mA	0.342	-	

<sup>\*</sup> Characteristics at  $T_1$ =25°C, measured in a continuous square wave pulse mode with a pulse width of 0.05msec and a duty cycle of 1%.

#### (3) Thermal Resistance

Item	Symbol	Part number	Тур	Max	Unit
	R <sub>0JS_real</sub>	NOONATOUT NOONAOAUT	2.4	2.8	°C/W
Thermal Resistance	R <sub>0JS_el</sub>	NC2W170HT, NC2W121HT	1.4	1.7	
	R <sub>0JS_real</sub>		2.4	2.8	
	$R_{\theta JS\_el}$	NC2W121HT-SC	1.6	1.9	

<sup>\*</sup> Thermal resistance values ( $R_{\theta JS\_real}$ ) determined by considering the energy conversion efficiency below. Refer to JESD51.

- NC2W170HT, NC2W121HT:  $\eta_e$ =45%

- NC2W121HT-SC :  $\eta_e = 37\%$ 

<sup>\*</sup> HBM ESD Component Classification Level of the LEDs: Class 3B For more details, see ANSI/ESDA/JEDEC JS-001.

<sup>\*</sup> The operating Temperature range is the range of soldering temperature  $(T_S)$ .

<sup>\*</sup> Luminous Flux value as per CIE 127:2007 standard.

<sup>\*</sup> Chromaticity Coordinates as per CIE 1931 Chromaticity Chart.

<sup>\*</sup> The maximum values are obtained using the statistical dispersion (i.e.  $+5\sigma$ ,  $\sigma$  stands for standard deviation).

### **RANKS**

Item	Part number	Rank	Min	Max	Unit
Forward Voltage	All 3 part numbers	-	6.0	6.9	V
		M950	950	1000	
	NC2W170HT	M900	900	950	
Luminous Flux	NC2W121HT	D880	880	900	
		M850	850	900	
		M750	750	800	lm
	NC2W121HT-SC	C720f2	720	750	
		M700	700	750	
		B690	690	700	

#### Color Ranks

	Rank Fnw59				
х	0.3166	0.3248	0.3296	0.3296	0.3215
У	0.3316	0.3481	0.3526	0.3456	0.3293

	Rank Fnw62				
x	0.3118	0.3214	0.3263	0.3167	
У	0.3220	0.3413	0.3390	0.3197	

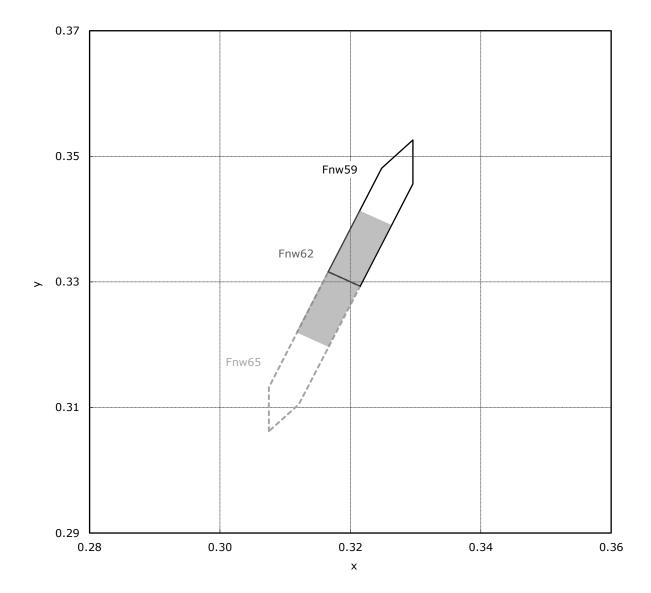
	Rank Fnw65					
х	0.3075	0.3075	0.3166	0.3215	0.3121	
У	0.3062	0.3132	0.3316	0.3293	0.3105	

- \* Ranks at  $T_3$ =25°C measured in a continuous square wave pulse mode with a pulse width of 0.05msec and a duty cycle of 1%.
- \* Forward Voltage Tolerance: ±0.07V
- \* Luminous Flux Tolerance: ±5%
- \* Chromaticity Coordinate Tolerance: ±0.003
- $^{*}$  LEDs from the above ranks will be shipped. The rank combination ratio per shipment will be decided by Nichia.

#### Luminous Flux Ranks by Color Rank

	NC2W170HT NC2W121HT	NC2W121HT-SC
Fnw59	M900,M950	C720f2,M750
Fnw62	D880,M900	M700,M750
Fnw65	M850,M900	B690,M700,M750

# CHROMATICITY DIAGRAM

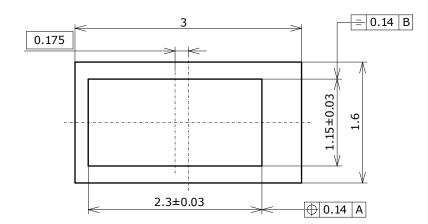


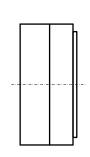
## **OUTLINE DIMENSIONS - NC2W170HT**

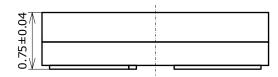
\* This product complies with RoHS Directive.

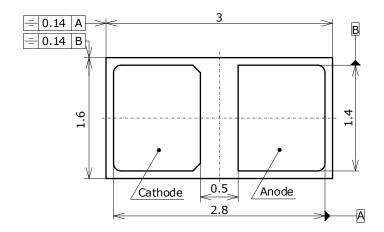
Part No. NC2W170H No. STS-DA7-21868

(Unit: mm, Tolerance: ±0.05)



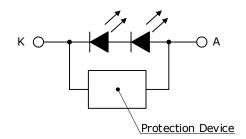






Item	Description
Package Materials	Ceramics
Phosphor sheet Materials	Phosphor Ceramics
Encapsulating Resin Materials	Silicone Resin
Electrodes Materials	Au-plated
Weight	0.012g(TYP)

- \* Dimensions do not include mold flash.
- \* The height of LED package is from the bottom of back electrode to the surface of emitting area.

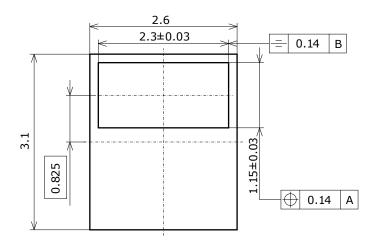


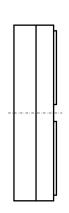
### **OUTLINE DIMENSIONS - NC2W121HT**

\* This product complies with RoHS Directive.

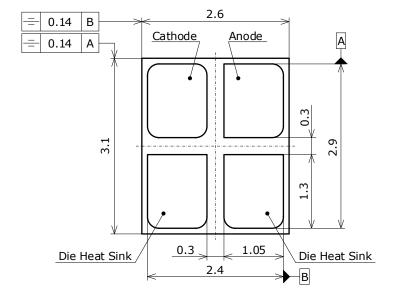
Part No. NC2W121H No. STS-DA7-21869

(Unit: mm, Tolerance: ±0.05)



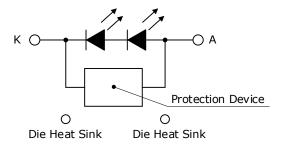






Item	Description	
Package Materials	Ceramics	
Phosphor sheet Materials	Phosphor Ceramics	
Encapsulating Resin Materials	Silicone Resin	
Electrodes Materials	Au-plated	
Die Heat Sink Materials	Au-plated	
Weight	0.019g(TYP)	

- \* Dimensions do not include mold flash.
- \* The height of LED package is from the bottom of back electrode to the surface of emitting area.

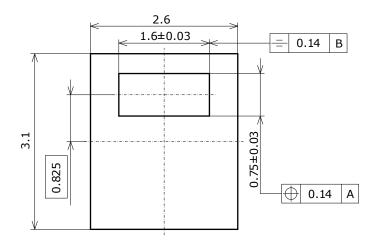


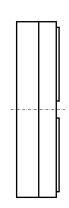
## OUTLINE DIMENSIONS - NC2W121HT-SC

\* This product complies with RoHS Directive.

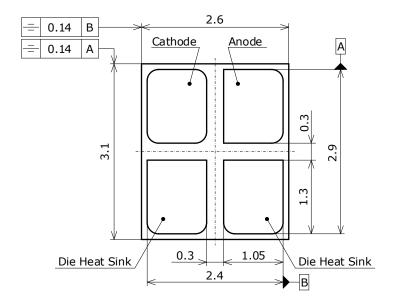
Part No. NC2W121H-SC No. STS-DA7-21857A

(Unit: mm, Tolerance: ±0.05)



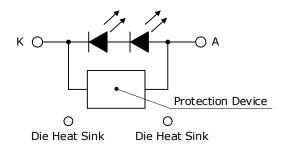






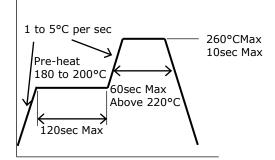
Item	Description	
Package Materials	Ceramics	
Phosphor sheet Materials	Phosphor Ceramics	
Encapsulating Resin Materials	Silicone Resin	
Electrodes Materials	Au-plated	
Die Heat Sink Materials	Au-plated	
Weight	0.018g(TYP)	

- \* Dimensions do not include mold flash.
- \* The height of LED package is from the bottom of back electrode to the surface of emitting area.



### **SOLDERING**

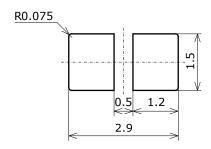
• Recommended Reflow Soldering Condition(Lead-free Solder)

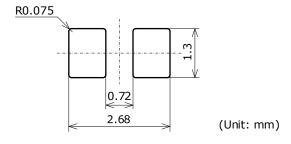


- \* This condition is recommended for all the part numbers to which the specification applies.
- Recommended Soldering Pad Pattern

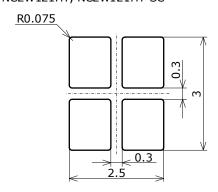
• Recommended Metal Solder Stencil Aperture

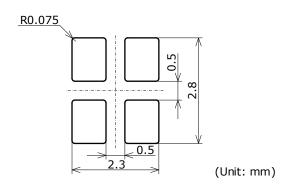






- NC2W121HT, NC2W121HT-SC





- \* This LEDs are designed to be reflow soldered to a PCB. If dip soldered or hand soldered, Nichia will not guarantee its reliability.
- \* Reflow soldering must not be performed more than twice.
- \* The reflow profile should be determined based on the recommended soldering conditions for the solder paste that is used.
- \* When cooling the LEDs from the peak temperature a gradual cooling slope is recommended; do not cool the LEDs rapidly.
- \* During reflow soldering, the heat and atmosphere in the reflow oven may cause the optical characteristics to degrade. In particular, reflow soldering performed with an air atmosphere may have a greater negative effect on the optical characteristics than if a nitrogen atmosphere is used; Nichia recommends using a nitrogen reflow atmosphere.

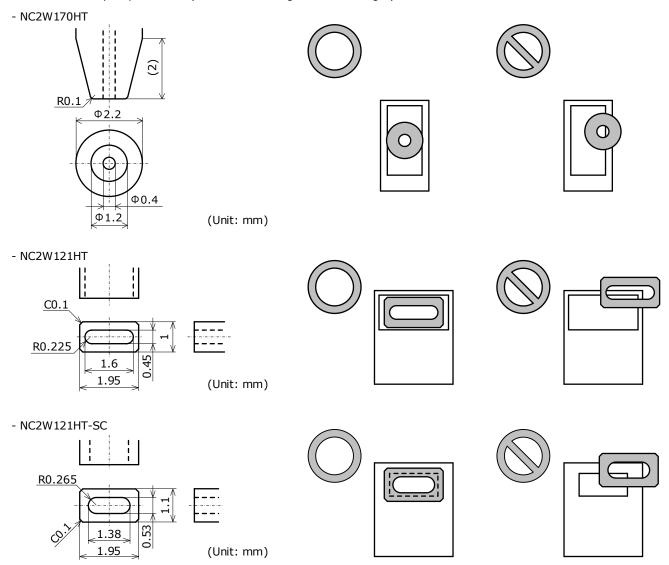
\* These LEDs use ceramics for the phosphor sheet (i.e. emitting surface); if excess pressure is applied to the ceramics, it may cause the ceramics to be damaged, chipped, cracked and/or deformed. If the ceramics is damaged, chipped, cracked and/or deformed, it may cause the internal connection to fail causing a catastrophic failure (i.e. the LEDs not to illuminate) and/or reliability issues (e.g. the LEDs to corrode and/or to become dimmer, the color/directivity to change, etc.).

Using a nozzle specifically designed for the LEDs is recommended (See the nozzle drawing below).

#### Nozzle contact area:

Recommended conditions:

The center of the phosphor sheet (See the second figure from the right)



If the nozzle is off-center and makes contact with the edges of the phosphor sheet (as shown in the figure to the right), it may cause the ceramic to chip/crack.

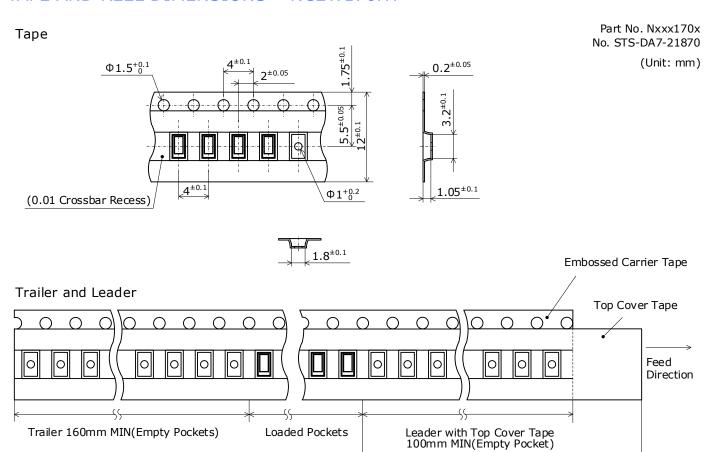
Placement pressure  $\leq 3.5 \text{N/mm}^2 * \text{max. force: } 5 \text{N}$ 

Vacuum pressure  $\leq 8N/cm^2$  ( $\leq 0.8kgf/cm^2$ )

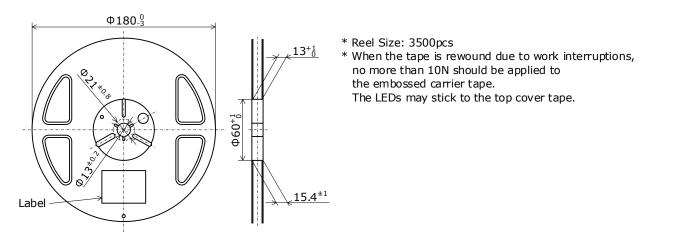
- \* Once the LEDs have been soldered to a PCB, it should not be repaired/reworked. If it must be done, using a hot plate is strongly recommended. Sufficient verification should be performed prior to use to ensure that the repair/rework does not cause the LED characteristics to deteriorate.
- \* When soldering, do not apply stress to the LEDs while the LEDs are hot.
- \* When using a pick and place machine, choose an appropriate nozzle for the LEDs.
- \* The soldering pad pattern above is a general recommendation for LEDs to be mounted without issues; if a high degree of precision is required for the chosen application (i.e. high-density mounting), ensure that the soldering pad pattern is optimized.
- \* When flux is used, it should be a halogen free flux. Ensure that the manufacturing process is not designed in a manner where the flux will come in contact with the LEDs.
- \* Ensure that there are no issues with the type and amount of solder that is being used.

\* These LEDs have all the electrodes on the backside; solder connections will not be able to be seen nor confirmed by a normal visual inspection. Ensure that sufficient verification is performed on the soldering conditions prior to use to ensure that there are no issues.

## TAPE AND REEL DIMENSIONS - NC2W170HT

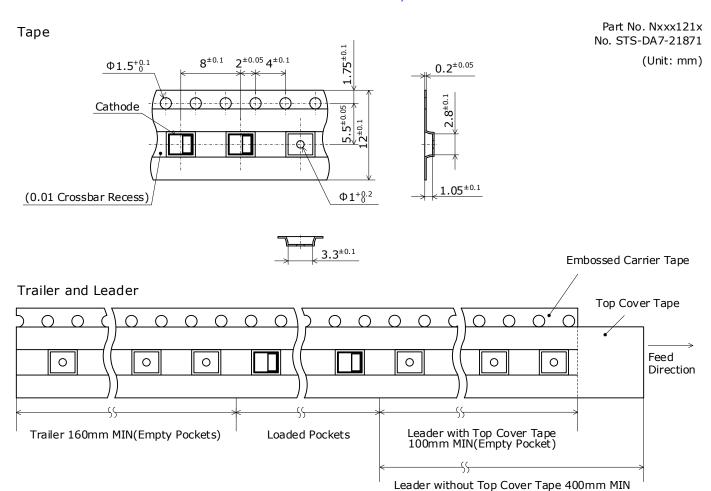


#### Reel

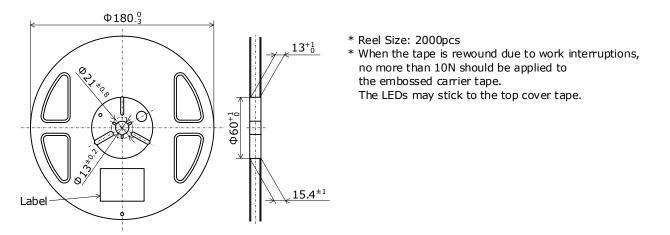


Leader without Top Cover Tape 400mm MIN

# TAPE AND REEL DIMENSIONS - NC2W121HT, NC2W121HT-SC



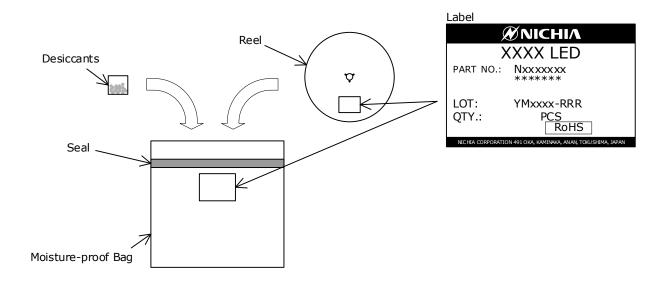
#### Reel



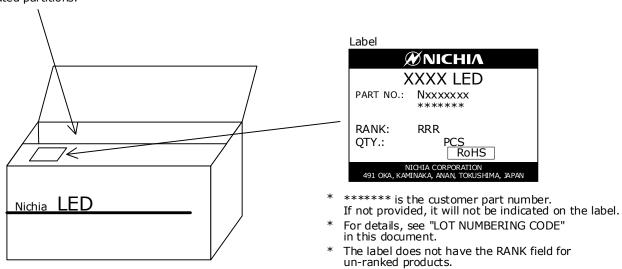
### PACKAGING - TAPE & REEL

Reels are shipped with desiccants in heat-sealed moisture-proof bags.

Part No. Nxxxxxx No. STS-DA7-21831



 $\label{thm:proof-bags} \mbox{ Anomaly noisy model} \mbox{ bags are packed in cardboard boxes with corrugated partitions.}$ 



- Products shipped on tape and reel are packed in a moisture-proof bag.
   They are shipped in cardboard boxes to protect them from external forces during transportation.
- \* Do not drop or expose the box to external forces as it may damage the products.
- \* Do not expose to water. The box is not water-resistant.
- \* Using the original package material or equivalent in transit is recommended.

### LOT NUMBERING CODE

Lot Number is presented by using the following alphanumeric code.

YMxxxx - RRR

Y - Year

Year	Y
2024	0
2025	Р
2026	Q
2027	R
2028	S
2029	Т

Thereafter, a letter of the alphabet is assigned to each year in alphabetical order.

M - Month

Month	М	Month	М	
1	1	7	7	
2	2	8	8	
3	3	9	9	
4	4	10	А	
5	5	11	В	
6	6	12	С	

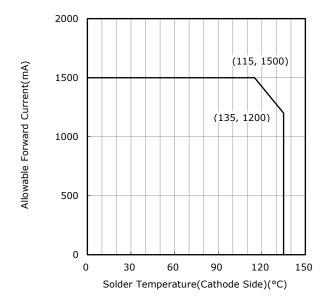
xxxx-Nichia's Product Number

RRR-Ranking by Color Coordinates, Ranking by Luminous Flux

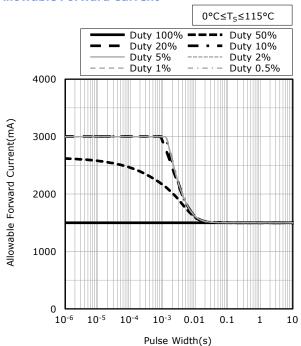
# DERATING CHARACTERISTICS - NC2W170HT, N2SW121HT

Part No. NC2W170H,NC2W121H No. STS-DA7-21872

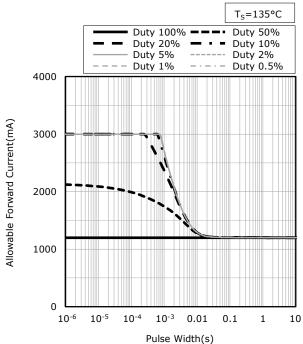
#### Solder Temperature(Cathode Side) vs Allowable Forward Current



#### Pulse Width vs Allowable Forward Current

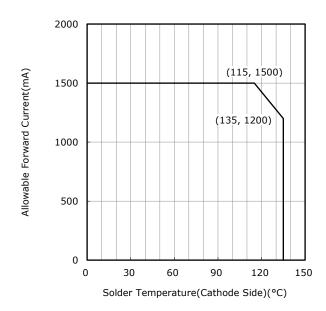


#### Pulse Width vs Allowable Forward Current

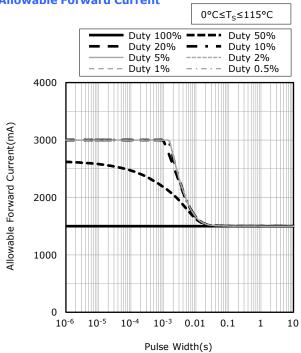


Part No. NC2W121H-SC No. STS-DA7-21858A

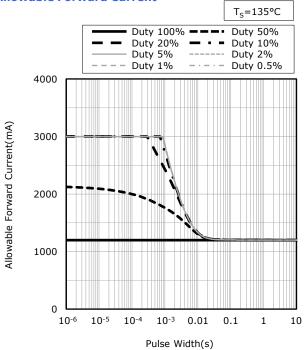
#### Solder Temperature(Cathode Side) vs Allowable Forward Current



#### Pulse Width vs Allowable Forward Current

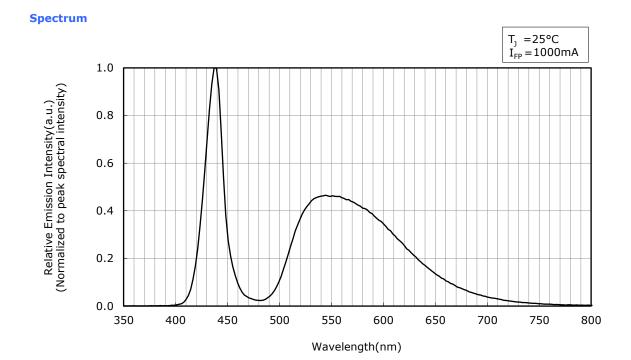


#### Pulse Width vs Allowable Forward Current

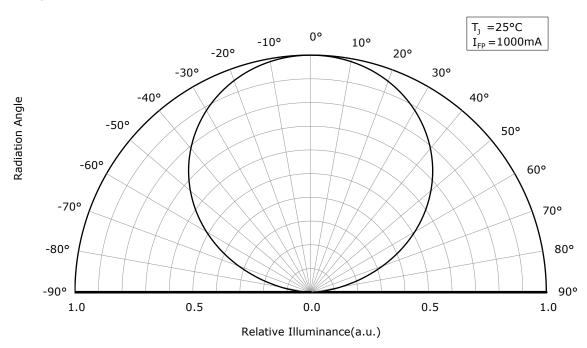


## **OPTICAL CHARACTERISTICS**

- \* All characteristics shown are for reference only and are not guaranteed.
- Part No. NC2W170H,NC2W121Hx No. STS-DA7-21873A
- \* Characteristics measured in a continuous square wave pulse mode with a pulse width of 0.05msec and a duty cycle of 1%.



#### **Directivity**



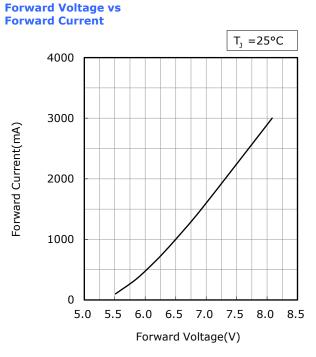
## FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

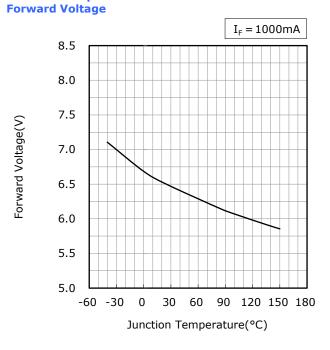
\* All characteristics shown are for reference only and are not guaranteed.

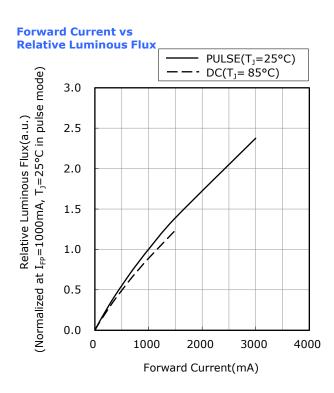
Part No. NC2W170H,NC2W121Hx No. STS-DA7-21874A

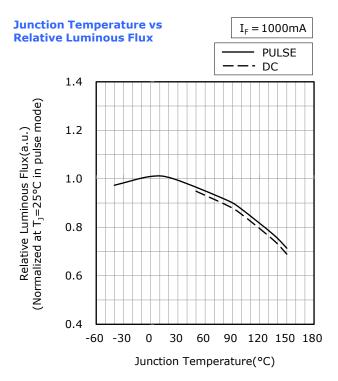
\* Characteristics measured in a continuous square wave pulse mode with a pulse width of 0.05msec and a duty cycle of 1%.

# Junction Temperature vs







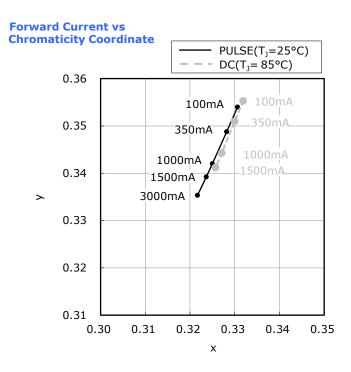


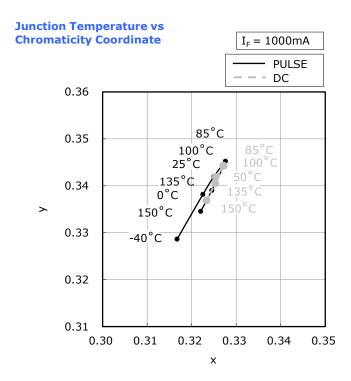
### FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

\* All characteristics shown are for reference only and are not guaranteed.

Part No. NC2W170H,NC2W121Hx No. STS-DA7-21875A

- Characteristics measured in a continuous square wave pulse mode with a pulse width of 0.05msec and a duty cycle of 1%.
- \* The following graphs show the characteristics moved the measurement value at  $I_{FP}=1000$ mA,  $T_{J}=25$ °C in pulse mode to the center point of color rank.





### **RELIABILITY**

(1) Tests and Results

Test	Reference Standard	Test Conditions	Test Duration	Failure Criteria #	Units Failed/Tested
Resistance to Soldering Heat (Reflow Soldering)	JEITA ED-4701 300 301	T <sub>sld</sub> =260°C, 10sec, 2reflows, Precondition: 85°C, 60%RH, 168hr		#1	0/10
Solderability	JEITA ED-4701 303 303A	T <sub>sld</sub> =245±5°C, 5sec, Lead-free Solder(Sn-3.0Ag-0.5Cu)		#2	0/10
Thermal Shock(Air to Air)		-40°C to 135°C, 15min dwell	1000cycles	#1	0/22
High Temperature Operating Life		T <sub>A</sub> =85°C, I <sub>F</sub> =1200mA	1000hours	#1	0/10
Temperature Humidity Intermittent Operating Life		T <sub>A</sub> =85°C, RH=85% I <sub>F</sub> =1200mA(30min ON/OFF)	1000hours	#1	0/10
Electrostatic Discharges	ANSI/ESDA/ JEDEC JS-001	HBM, 8kV, $1.5k\Omega$ , $100pF$ , $1pulse$ , alternately positive or negative		#1	0/10

#### NOTES:

- 1) R<sub>θJA</sub>≈8°C/W
- 2) Measurements are performed after allowing the LEDs to return to room temperature.

(2) Failure Criteria

1				
Criteria # Items		Conditions	Failure Criteria	
	Famus and Maltage (M.)	I 1000 A	<initial td="" value×0.9<=""></initial>	
#1	Forward Voltage(V <sub>F</sub> )	I <sub>F</sub> =1000mA	>Initial value×1.1	
	Luminous Flux(Φ <sub>ν</sub> )	I <sub>F</sub> =1000mA	<initial td="" value×0.8<=""></initial>	
			>Initial value×1.2	
#2	Solderability	-	Less than 95% solder coverage	

### **CAUTIONS**

#### (1) Storage

	Conditions	Temperature	Humidity	Time
	Before Opening Aluminum Bag	≤30°C	≤90%RH	Within 1 Year from Delivery Date
Storage	After Opening Aluminum Bag	≤30°C	≤70%RH	≤1year

- The storage/packaging requirements for the LEDs are comparable to JEDEC Moisture Sensitivity Level (MSL) 2 or equivalent. Nichia used IPC/JEDEC STD-020 as a reference to rate the MSL of the LEDs.
- These LEDs use a package that could absorb moisture; if the package absorbs moisture and is exposed to heat during soldering, it may cause the moisture to vaporize and the package to expand and the resulting pressure may cause internal delamination. This may cause the optical characteristics to degrade. To minimize moisture absorption in storage/transit, moisture-proof aluminum bags are used for the LEDs with a silica gel packet to absorb any air moisture in the bag. The silica gel beads turn blue to red as they absorb moisture.
- Once the moisture-proof aluminum bag is open, ensure that the LEDs are soldered to a PCB within the range of the conditions above. To store any remaining unused LEDs, use a hermetically sealed container with silica gel desiccants. Nichia recommends placing them back to the original moisture-proof bag and reseal it.
- The parts/materials (e.g. housing, gasket/seal, secondary lens, lens cover, thermal grease, etc.) used with the LEDs in the same assembly/system may release corrosive gases containing sulfur, halogens, etc. A light-up test, sufficient verifications, etc. must be performed at the finished product level (i.e. automotive headlamp, luminaire, etc.) prior to use taking into consideration the conditions/environments in which the finished product will actually be used to ensure that the expected performance for the finished product is maintained. See below for the detailed information.

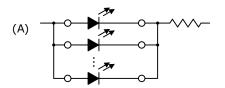
Issues that may be caused by corrosive gases containing sulfur, halogens, etc.:

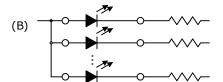
These LEDs have plated parts. If the LEDs are exposed to corrosive gases containing sulfur, halogens, etc., it may cause the plated surface to tarnish. If the gases penetrate the LEDs (e.g. emitting surface, package material, etc.), it may cause the surface of the plated parts inside the package to tarnish. In addition, it has been confirmed that if a silicone resin is used in the LEDs, the gases may accelerate degradation of the silicone resin. As a result, the optical characteristics may be adversely affected (i.e. significant reduction in the brightness, significant color shift, etc.); in the worst case, the circuit could become open causing a catastrophic failure (i.e. the LEDs not to illuminate). When determining the storage environment for the LEDs and/or selecting parts/materials that will be used with the LEDs in the finished product, it must be ensured prior to use that corrosive gases containing sulfur, halogens, etc. are not generated.

- To avoid condensation, the LEDs must not be stored in areas where temperature and humidity fluctuate greatly.
- Do not store the LEDs in a dusty environment.
- Do not expose the LEDs to direct sunlight and/or an environment over a long period of time where the temperature is higher than normal room temperature.

#### (2) Directions for Use

• The circuit must be designed to ensure that the Absolute Maximum Ratings are not exceeded for each LED. The LEDs should be operated at a constant current per LED. In the case of operating at a constant voltage, Circuit B is recommended. If Circuit A is used, it may cause the currents flowing through the LEDs to vary due to the variation in the forward voltage characteristics of the LEDs on the circuit.





- These LEDs are designed to be operated at a forward current. Ensure that no voltage is applied to the LEDs in the forward/reverse direction while the LEDs are off. If the LEDs are used in an environment where reverse voltages are applied to the LEDs continuously, it may cause electrochemical migration to occur causing the LEDs to be damaged. When not in use for a long period of time, the system's power should be turned off to ensure that there are no issues/damage.
- To stabilize the LED characteristics while in use, Nichia recommends that the LEDs are operated at currents ≥ 10% of the sorting current.
- Ensure that transient excessive voltages (e.g. lightning surge) are not applied to the LEDs.
- If the LEDs are used for outdoor applications, ensure that necessary measures are taken (e.g. protecting the LEDs from water/salt damage and high humidity).

#### (3) Handling Precautions

- Do not handle the LEDs with bare hands as it will contaminate the LED surface and may affect the optical characteristics: it might cause the LEDs to be deformed and/or the bump to break, which will cause the LEDs not to illuminate.
- Ensure that when handling the LEDs with tweezers, excessive force is not applied to the LEDs. Otherwise, it may cause damage to the resin (e.g. cut, scratch, chip, crack, delamination and deformation) and the internal connection to fail causing a catastrophic failure (i.e. the LEDs not to illuminate).
- Dropping may cause damage to the LEDs (e.g. deformation).
- Do not stack assembled PCBs together. Otherwise, it may cause damage to the resin (e.g. cut, scratch, chip, crack, delamination and deformation) and the internal connection to fail causing a catastrophic failure (i.e. the LEDs not to illuminate).

#### (4) Design Consideration

- If the LEDs are soldered to a PCB and the PCB assembly is bent (e.g. PCB depanding process), it may cause the LED package to break. The PCB layout should be designed to minimize the mechanical stress on the LEDs when the PCB assembly is bent/warped.
- The amount of mechanical stress exerted on the LEDs from depanding may vary depending on the LED position/orientation on the PCB assembly (e.g. especially in areas near V-groove scores). The PCB layout should be designed to minimize the mechanical stress on the LEDs when the PCB is separated into individual PCB assemblies.
- To separate a PCB populated with the LEDs, use a specially designed tool. Do not break the PCB by hand.
- The parts/materials (e.g. housing, gasket/seal, secondary lens, lens cover, thermal grease, etc.) used with the LEDs in the same assembly/system may release corrosive gases containing sulfur, halogens, etc., and/or volatile organic compounds (VOCs). A light-up test, sufficient verifications, etc. must be performed at the finished product level (i.e. automotive headlamp, luminaire, etc.) prior to use taking into consideration the conditions/environments in which the finished product will actually be used to ensure that the expected performance for the finished product is maintained. See below for the detailed information.

Issues that may be caused by corrosive gases containing sulfur, halogens, etc.:

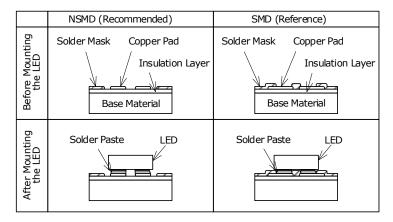
These LEDs have plated parts. If the LEDs are exposed to corrosive gases containing sulfur, halogens, etc., it may cause the plated surface to tarnish. If the gases penetrate the LEDs (e.g. emitting surface, package material, etc.), it may cause the surface of the plated parts inside the package to tarnish. In addition, it has been confirmed that if a silicone resin is used in the LEDs, the gases may accelerate degradation of the silicone resin. As a result, the optical characteristics may be adversely affected (i.e. significant reduction in the brightness, significant color shift, etc.); in the worst case, the circuit could become open causing a catastrophic failure (i.e. the LEDs not to illuminate). When determining the storage environment for the LEDs and/or selecting parts/materials that will be used with the LEDs in the finished product, it must be ensured prior to use that corrosive gases containing sulfur, halogens, etc. are not generated.

#### Issues that may be caused by VOCs:

If VOCs that have been released from the parts/materials and/or organic additives used with the LEDs in the finished product penetrate into the LEDs and remain inside the LEDs, the VOCs can discolor after being exposed to heat and/or photon energy. This may cause the optical characteristics to be adversely affected (i.e. significant reduction in the brightness, significant color shift, etc.). This adverse effect may be improved by ventilating the environment (i.e. the LEDs are not used in a hermetically sealed environment) to prevent the VOCs from remaining inside the LEDs. When selecting parts/materials that will be used with the LEDs in the finished product, it must be ensured prior to use that there are no issues with the substances found in those parts/materials and/or that the expected performance for the finished product is maintained by performing a light-up test, sufficient verifications etc. taking into consideration the conditions/environments in which the finished product will actually be used.

- If the solder paste and/or the PCB (e.g. base material, insulation material, soldering pad patterns, etc.) are not appropriate, it may cause thermal stress in the solder joints resulting in cracks. A thorough verification should be performed with the chosen solder paste and PCB prior to use to ensure there are no issues, this verification should be performed taking into consideration the conditions/environments in which the end-product containing these LEDs will actually be used.
- If a metal-core PCB is used to operate the LEDs, it may cause thermal stress during operation causing damage to the solder joints (e.g. crack). Ensure that sufficient verification is performed prior to use. Nichia recommends using a metal-core PCB with a low elastic modulus insulating layer.
- Ensure that the chosen soldering pad pattern has a solder mask which does not cover the copper pads that the LEDs will be attached to or the area underneath the LEDs.

(Non Solder Mask Defined [NSMD] pads are recommended; see the figure below.)



#### (5) Electrostatic Discharge (ESD)

• The LEDs are sensitive to transient excessive voltages (e.g. ESD, lightning surge). If this excessive voltage occurs in the circuit, it may cause the LEDs to be damaged causing issues (e.g. the LEDs to become dimmer or not to illuminate [i.e. catastrophic failure]).

Ensure that when handling the LEDs, necessary measures are taken to protect them from an ESD discharge. The following examples are recommended measures to eliminate the charge:

- Grounded wrist strap, ESD footwear, clothes, and floors
- Grounded workstation equipment and tools
- ESD table/shelf mat made of conductive materials
- Ensure that all necessary measures are taken to prevent the LEDs from being exposed to transient excessive voltages (e.g. ESD, lightning surge):
  - tools, jigs, and machines that are used are properly grounded
  - appropriate ESD materials/equipment are used in the work area
  - the system/assembly is designed to provide ESD protection for the LEDs
- If the tool/equipment used is an insulator (e.g. glass cover, plastic, etc.), ensure that necessary measures have been taken to protect the LEDs from transient excessive voltages (e.g. ESD). The following examples are recommended measures to eliminate the charge:
  - Dissipating static charge with conductive materials
  - Preventing charge generation with moisture
  - Neutralizing the charge with ionizers
- To detect if an LED was damaged by transient excess voltages (i.e. an ESD event during the system's assembly process), perform a characteristics inspection (e.g. forward voltage measurement, light-up test) at low current (≤1mA).
- Failure Criteria: V<sub>F</sub><4.0V at I<sub>F</sub>=0.5mA

If the LEDs are damaged by transient excess voltages (e.g. ESD), it will cause:

- the Forward Voltage (V<sub>F</sub>) to decrease
- the LEDs not to illuminate at a low current

#### (6) Thermal Management

- The Absolute Maximum Junction Temperature (T<sub>1</sub>) must not be exceeded under any circumstances. The increase in the temperature of an LED while in operation may vary depending on the PCB thermal resistance and the density of LEDs on the PCB assembly. Ensure that when using the LEDs for the chosen application, heat is not concentrated in an area and properly managed in the system/assembly.
- The operating current should be determined by considering the temperature conditions surrounding the LEDs (i.e. T<sub>A</sub>). Ensure that when operating the LEDs, proper measures are taken to dissipate the heat.
- The chosen thermal design must ensure that the Absolute Maximum Junction Temperature (T<sub>J</sub>) will not be exceeded. Nichia recommends that the maximum values for the thermal resistances provided in the SPECIFICATIONS section under "Thermal Resistance" and the highest input power being used under the chosen conditions are taken into consideration for the thermal design. If they are not taken into consideration, perform sufficient verification prior to use under the actual operating conditions/environments where the LEDs will be used to ensure that there will be no issues with the chosen thermal design.

#### (7) Cleaning

- Do not clean the LEDs with water, benzine and/or thinner.
- To clean the LEDs, use isopropyl alcohol (IPA). If another solvent is used, it may cause the LED package/resin to be damaged causing issues; ensure that sufficient verification is performed prior to use. Additionally, ensure that the solvent being used does not cause any other issues (e.g. CFC-based solvents are heavily regulated).
- If an LED is contaminated (e.g. dust/dirt), use a cloth soaked with isopropyl alcohol (IPA). Ensure that the cloth is firmly squeezed before wiping the LED.
- Do not clean the LEDs with an ultrasonic cleaner. If cleaning must be done, ensure that sufficient verification is performed by using a finished assembly with the LEDs to determine cleaning conditions (e.g. ultrasonic power, LED position on the PCB assembly) that do not cause an issue.

#### (8) Eye Safety

- There may be two important international specifications that should be noted for safe use of the LEDs: IEC 62471:2006

  Photobiological safety of lamps and lamp systems and IEC 60825-1:2001 (i.e. Edition 1.2) Safety of Laser Products Part 1:

  Equipment Classification and Requirements. Ensure that when using the LEDs, there are no issues with the following points:
  - LEDs have been removed from the scope of IEC 60825-1 since IEC 60825-1:2007 (i.e. Edition 2.0) was published. However, depending on the country/region, there are cases where the requirements of the IEC 60825-1:2001 specifications or equivalent must be adhered to.
  - LEDs have been included in the scope of IEC 62471:2006 since the release of the specification in 2006.
  - Most Nichia LEDs will be classified as the Exempt Group or Risk Group 1 according to IEC 62471:2006. However, in the case
    of high-power LEDs containing blue wavelengths in the emission spectrum, there are LEDs that will be classified as Risk
    Group 2 depending on the characteristics (e.g. radiation flux, emission spectrum, directivity, etc.)
  - If the LEDs are used in a manner that produces an increased output or with an optic to collimate the light from the LEDs, it may cause damage to the human eye.
- If an LED is operated in a manner that emits a flashing light, it may cause health issues (e.g. visual stimuli causing eye discomfort).

  The system should be designed to ensure that there are no harmful effects on the human body.

#### (9) Miscellaneous

- Nichia warrants that the discrete LEDs will meet the requirements/criteria as detailed in the Reliability section within this specification. If the LEDs are used under conditions/environments deviating from or inconsistent with those described in this specification, the resulting damage and/or injuries will not be covered by this warranty.
- Nichia warrants that the discrete LEDs manufactured and/or supplied by Nichia will meet the requirements/criteria as detailed in the Reliability section within this specification; it is the customer's responsibility to perform sufficient verification prior to use to ensure that the lifetime and other quality characteristics required for the intended use are met.
- The applicable warranty period is one year from the date that the LEDs are delivered. In the case of any incident that appears to be in breach of this warranty, the local Nichia sales representative should be notified to discuss instructions on how to proceed while ensuring that the LED in question is not disassembled or removed from the PCB if it has been attached to the PCB. If a breach of this warranty is proved, Nichia will provide the replacement for the non-conforming LED or an equivalent item at Nichia's discretion. FOREGOING ARE THE EXCLUSIVE REMEDIES AVAILABLE TO THE CUSTOMER IN RESPECT OF THE BREACH OF THE WARRANTY CONTAINED HEREIN, AND IN NO EVENT SHALL NICHIA BE RESPONSIBLE FOR ANY INDRECT, INCIDENTAL OR CONSEQUENTIAL LOSSES AND/OR EXPENSES (INCLUDING LOSS OF PROFIT) THAT MAY BE SUFFERED BY THE CUSTOMER ARISING OUT OF A BREACH OF THE WARRANTY.
- NICHIA DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, INCLUDING THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE.
- The LEDs are intended to be used for general lighting, household appliances, electronic devices (e.g. mobile communication devices) and automobiles; the LEDs are not designed or manufactured for use in applications that require safety critical functions (e.g. aircraft, combustion equipment, life support systems, nuclear reactor control system, safety devices, spacecraft, submarine repeaters, traffic control equipment, trains, vessels, etc.). If the LEDs are planned to be used for these applications, unless otherwise detailed in the specification, Nichia will neither guarantee that the LEDs are fit for that purpose nor be responsible for any resulting property damage, injuries and/or loss of life/health.
- The customer will not reverse engineer, disassemble or otherwise attempt to extract knowledge/design information from the LEDs.
- All copyrights and other intellectual property rights in this specification in any form are reserved by Nichia or the right holders who have granted Nichia permission to use the content. Without prior written permission from Nichia, no part of this specification may be reproduced in any form or by any means.
- Both the customer and Nichia will agree on the official specifications for the supplied LEDs before any programs are officially launched. Without this agreement in writing (i.e. Customer Specific Specification), changes to the content of this specification may occur without notice (e.g. changes to the foregoing specifications and appearance, discontinuation of the LEDs, etc.).